



#### **Features**

• Ideal for indication light on hand held products

• Long life and robust package

• Variety of lens types and color choices available

ullet Package : 1500pcs / reel

• Moisture sensitivity level : level 3

• RoHS compliant

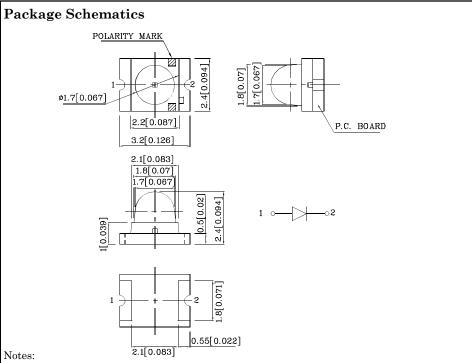






# ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE

SENSITIVE DEVICES



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1 (0.004")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)	M2DG (InGaN)	Unit		
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	$I_{\mathrm{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	100	mA	
Power Dissipation	$P_{D}$	120	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		
Electrostatic Discharge Threshold (HBM)	450	V		

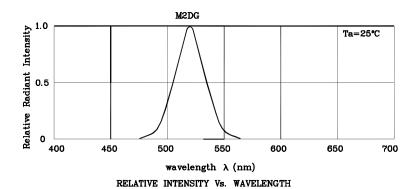
Operating Characteristics (T <sub>A</sub> =25°C)		M2DG (InGaN)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	3.2	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	4	V
Reverse Current (Max.) $(V_R=5V)$	${ m I}_{ m R}$	50	uA
Wavelength of Peak Emission (Typ.) $(I_F=20 \text{mA})$	λΡ	520	nm
Wavelength of Dominant Emission (Typ.) $(I_F=20\text{mA})$	λD	525	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	35	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	C	100	pF

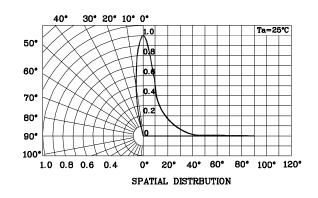
Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous} \\ \text{Intensity} \\ \text{(I}_F = 20 \text{mA)} \\ \text{mcd} \end{array}$		Wavelength nm λΡ	Viewing Angle 20 1/2
				min.	typ.		
XZM2DG147W	Green	InGaN	Water Clear	4000	5490	520	20°

Jul 01,2011 XDSB6192 V1 Layout: Maggie L.

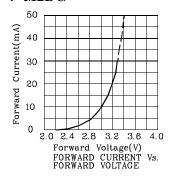


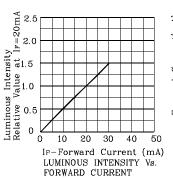


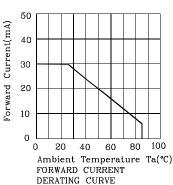


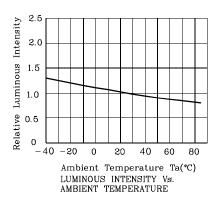


#### **❖ M2DG**



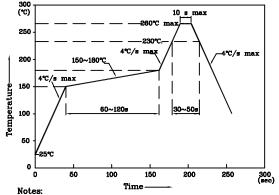






# LED is recommended for reflow soldering and soldering profile is shown below.

## Reflow Soldering Profile for SMD Products (Pb-Free Components)

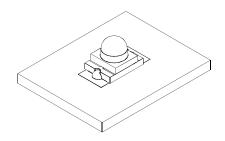


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

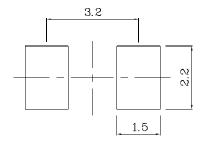




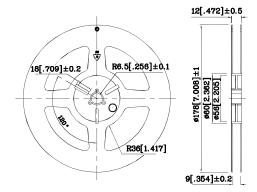
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



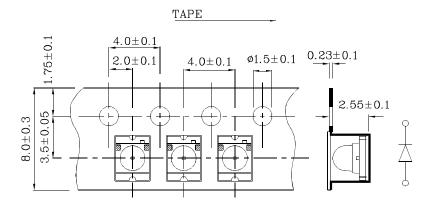
**♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



#### **❖** Reel Dimension



## **❖** Tape Specification (Units:mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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#### PACKING & LABEL SPECIFICATIONS

